

BN-1 – Silicon Nitride

MATERIAL TECHNICAL DATA SHEET

TRADE NAME:	BN-1	
MATERIAL DESCRIPTION Chemical Name & Formula:	Silicon Nitride – Si ₃ N ₄	
	0.5.14	
Si ₃ N ₄ (+ Al ₂ O ₃ ; Y ₂ O ₃):	99% min	
PHYSICAL DATA		
Physical Form:	Polycrystalline structur	e
Boiling Temperature:	N.A.	
Vapour Pressure:	N.A.	
Evaporation Rate:	N.A.	
Specific gravity:	N.A.	
Density:	3,22g/cm ³	
Water solubility:	Insoluble	
Colour:	Dark Grey	
Odour:	None	
MECHANICAL PROPERTIES AT ROOM TEMPERATURE		
Water Absorption	%	
Vickers Hardness	(HV 0,5)	
Flexural Strength	MPa	
Compressive Strength	MPa	
Young's Modulus	GPa	
Maximum service temperature	°C	
Thermal Conductivity @20°C	W/(m⋅K)	
Thermal Expansion Coefficient (RT-800°C	C) 10⁻ ⁶ /°C	
Thermal Shock Resistance (ΔT)	°C	

PHYSICAL AND CHEMICAL PROPERTIES

Good thermal shock resistance, excellent wear and corrosion resistance.

Please, note that all values quoted are based on test pieces and may vary according to component design. These values are not guaranteed in any way and should only be treated as indicative values. They should be used for guidance only and for no other purpose.



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